

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t3663hms8e-5#pbf

(Engineering Calculation)

MSOP-Exposed

(printed on: 2020-07-11 18:12:50)

**TOTAL MASS (g) : 0.026305**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001221	1000000	46416.9882812		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.010433	975000	396616.21875		
		Iron (Fe)	7439-89-6	0.000257	24000	9769.99707031		
		Phosphorus (P)	7723-14-0	0.000003	300	114.046653748		
		Zinc (Zn)	7440-66-6	0.000007	700	266.108825684		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.010700</b>	<b>1000000</b>	<b>406766.375</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	26991.9902344		
		<b>External Plating Total:</b>				<b>0.000710</b>	<b>1000000</b>	<b>26991.9902344</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	3269.33740234		
<b>Internal Plating Total:</b>				<b>0.000086</b>	<b>1000000</b>	<b>3269.33740234</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000507	750000	19273.8847656		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000169	250000	6424.62841797		
<b>Die Attach Total:</b>				<b>0.000676</b>	<b>1000000</b>	<b>25698.5136719</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001659	130000	63067.7929688		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010591	830000	402622.6875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000447	35000	16992.9511719		
		Carbon Black (C)	1333-86-4	0.000064	5000	2432.99536133		
		<b>Encapsulation Total:</b>				<b>0.012761</b>	<b>1000000</b>	<b>485116.4375</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000151	1000000	5740.34765625		
					<b>TOTAL MASS (g) :</b>	<b>0.026305</b>		